

C & N ASSOCIATES

MANUFACTURERS REPRESENTATIVES SINCE 1970

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<p>AMETHERM http://www.ametherm.com</p>	<p>U.S manufacturer of NTC Thermistors, along with inrush current limiters for various power applications with outputs from 50 to 7,500 watts and 1.0 to 50 AMPs SSI. Limit up to 900 joules of inrush energy; UL & CSA rated</p>
<p>APPLIED POWER SYSTEMS http://www.appliedps.com</p>	<p>U.S. designer and manufacturer of power systems: Inverters, Converters, rectifier assemblies, and power supplies, air or liquid cooled versions. Drivers for IGBTs, SCRs and MOSFETS.</p>
<p>CORNELL DUBILIER http://www.cde.com</p>	<p>Capacitors: aluminum electrolytic, screw terminal, snap in, miniature and radial Surface mount film, mica, polymer and aluminum capacitors. High voltage A.C. capacitors. MLS/MLP flat pack hermetically sealed. ILLINOIS CAPACITOR - These products include: aluminum electrolytic, metalized film, power film, supercapacitors (ultra-capacitors)</p>
<p>ELECTROSWITCH http://www.electro-nc.com</p>	<p>Rotary Switches: open frame, enclosed, and sub-miniature. Miniature rocker, toggle, paddle & push button switches. Magnetic and mechanical encoders, solenoid assemblies. Indicator lights. CTI - Industrial keyboards, mouse pointing devices, industrial analog joysticks, trackballs, analog/digital motion controllers, NEMA (IP66) momentary switches. CW Switches - Slide Switches, Commercial and Mil-Spec connectors include socket connectors, header connectors, D-Subminiature connectors, card edge Connectors, DIP connectors, and PCB connectors.</p>
<p>KNOWLES CAPACITORS http://www.knowlescapacitors.com</p>	<p>NOVACAP - MLC capacitors, high reliability & commercial for Medical Implant, Aerospace, Military and Telecom/Computer applications in SMT and leaded configurations. Temp range -55 to +300° C. 4VDC to 10KVDC. SYFER - Chip capacitors: FlexiCap™ polymer termination, UL approved class X & Y, high voltage, large case size, and radial leaded. EMI filters: EMI chips, SMD pi-filters, X2Y chips, chassis mount filters and planar array</p>
<p>MICROPAC INDUSTRIES, Inc. http://www.micropac.com</p>	<p>High reliability optocouplers, LEDs, Hall Effect sensors, solid state relays, solid state power controllers, power operational amplifiers and optically isolated MOSFET switches. Electronic assemblies and multi-chip microelectronic modules</p>
<p>MITSUBISHI http://www.mitsubishielectric.com/semiconductors/products/powermod/index.html</p>	<p>Power Modules: DIPIPM's, IPM, IGBT modules, HVIGBT. Power MOSFET, Diode Modules, SiC Power Devices</p>
<p>OHMITE www.ohmite.com</p>	<p>Resistors- Precision, High Power, High Current, High Voltage, Surge, Current Sense. Multiple constructions include Wirewound, Thick Film, and Composition. EMI/EMC- From single phase inlet filters up to three phase book shelf designs. Ohmite EMI filters meet relevant safety certifications including UL and CSA.</p>
<p>RENCO http://www.rencousa.com</p>	<p>Chokes, Common Mode Chokes, Inductors, Surface Mounts, Toroids, and Transformers. Manufacturing capabilities in USA and China.</p>
<p>ROTECH http://www.rotech-busbar.com</p>	<p>Leader in the field of laminated bus structures for the interconnection of IGBT/IPM devices. Wide range of manufacturing experience in backplane, multilayer laminate and power conversion bus bars.</p>
<p>STANDEX ELECTRONICS http://www.standexelectronics.com</p>	<p>Manufacture of standard and custom magnetics. Planar, Current Sense Transformers. Low and High Frequency Mil-Aero Magnetics. Reed Switches and Sensors and Magnets. Liquid Level Sensors and Reed Relays.</p>
<p>WAKEFIELD- VETTE http://www.wakefield-vette.com</p>	<p>Thermal Extrusions, Bonded Fin, Folded Fin and Liquid Cold Plates. Board Level, BGA and LED heat sinks Thermal compounds, pads and tape, heat pipes and cooling assemblies. Wedgelocks, front Panels, enclosures, and subracks.</p>